

Ultrafast Rectifier, 1 A FRED Pt®

eSMP® Series


SMP (DO-220AA)

Cathode  Anode

DESIGN SUPPORT TOOLS

[click logo to get started](#)


PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1 A
V_R	100 V, 200 V
V_F at I_F	0.69 V
I_{FSM}	40 A
t_{rr} (typ.)	23 ns
T_J max.	175 °C
Package	SMP (DO-220AA)
Circuit configuration	Single

FEATURES

- Very low profile - typical height of 1.0 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- For PFC, CRM snubber operation
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATION

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber industrial and automotive applications.

MECHANICAL DATA

Case: SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 33-N102

Polarity: color band denotes cathode end

ABSOLUTE MAXIMUM RATINGS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	VS-1ENH01-M3	V_{RRM}		100	V
	VS-1ENH02-M3			200	
Average rectified forward current		$I_{F(AV)}$	$T_C = 168\text{ }^{\circ}\text{C}$	1	A
Non-repetitive peak surge current		I_{FSM}	$T_J = 25\text{ }^{\circ}\text{C}$, 10 ms sine pulse	40	
Operating junction and storage temperatures		T_J, T_{Stg}		-55 to +175	$^{\circ}\text{C}$

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	VS-1ENH01-M3	V _{BR} , V _R	I _R = 100 μA	100	-	-	V
	VS-1ENH02-M3			200	-	-	
Forward voltage		V _F	I _F = 1 A	-	0.86	0.92	
			I _F = 1 A, T _J = 150 °C	-	0.69	0.74	
Reverse leakage current		I _R	V _R = V _R rated	-	-	2	μA
			T _J = 150 °C, V _R = V _R rated	-	-	20	
Junction capacitance		C _T	V _R = 200 V	-	8	-	pF



DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t_{rr}	$I_F = 1.0\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$	-	23	-	ns
		$I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$	-	-	28	
		$T_J = 25\text{ }^{\circ}\text{C}$	-	14	-	
		$T_J = 125\text{ }^{\circ}\text{C}$	-	22	-	
Peak recovery current	I_{RRM}	$T_J = 25\text{ }^{\circ}\text{C}$	-	1.7	-	A
		$T_J = 125\text{ }^{\circ}\text{C}$	-	2.7	-	
Reverse recovery charge	Q_{rr}	$T_J = 25\text{ }^{\circ}\text{C}$	-	10	-	nC
		$T_J = 125\text{ }^{\circ}\text{C}$	-	29	-	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range		T _J , T _{Stg}		-55	-	175	°C
Thermal resistance, junction mount		R _{thJM} ⁽¹⁾	Infinite heatsink	-	7	9	°C/W
Thermal resistance, junction to ambient		R _{thJA}	PCB footprint 4.8 mm x 4.8 mm	-	107	-	
Marking device	VS-1ENH01-M3		Case style SMP (DO-220AA)	1H1			
	VS-1ENH02-M3			1H2			

Note

(1) Thermal resistance junction to mount follows JEDEC® 51-14 transient dual interface test method (TDIM)

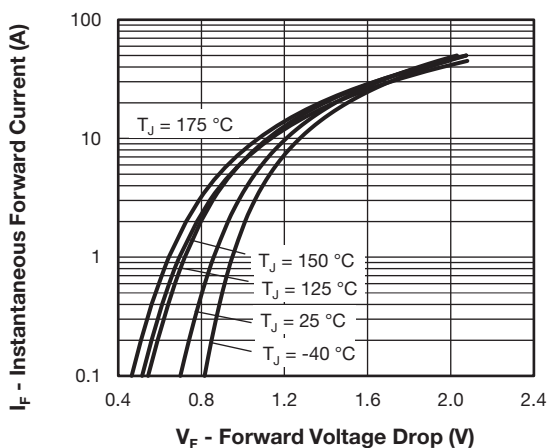


Fig. 1 - Typical Forward Voltage Drop Characteristics

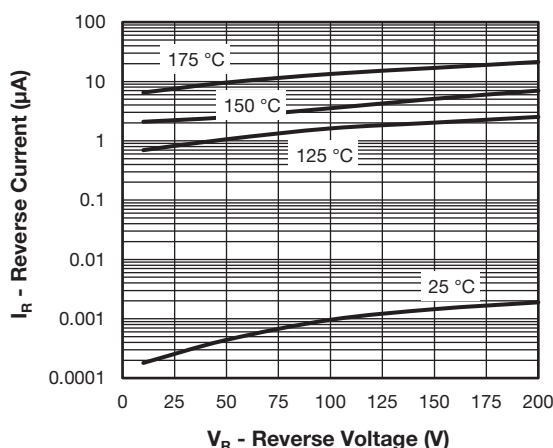


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

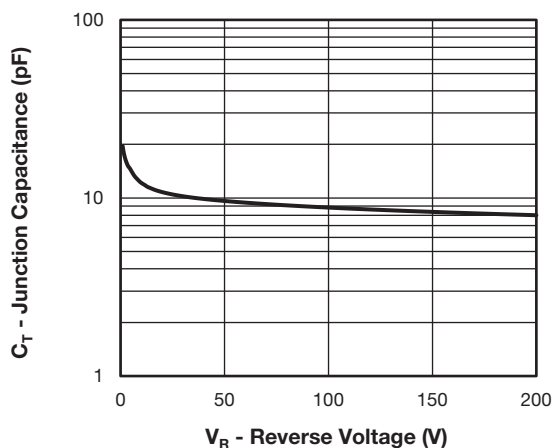


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

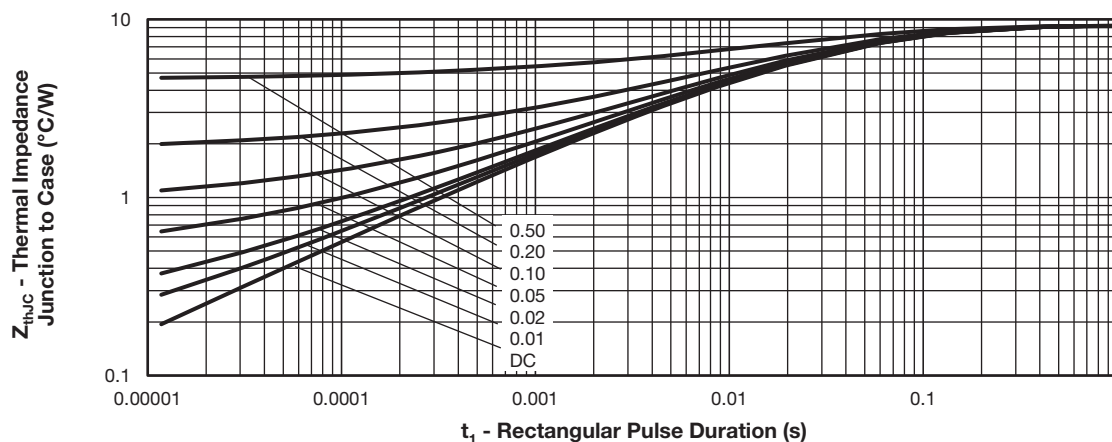


Fig. 4 - Transient Thermal Impedance, Junction to Case

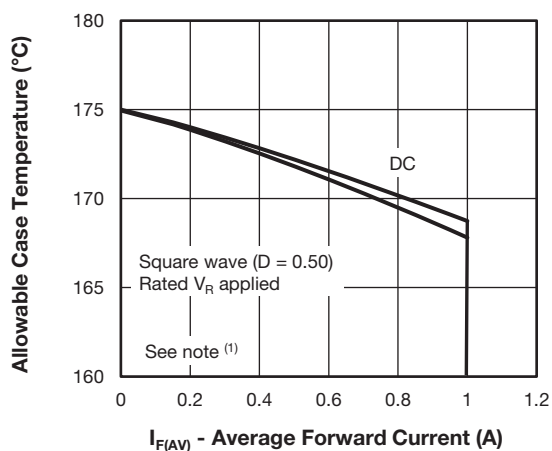


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

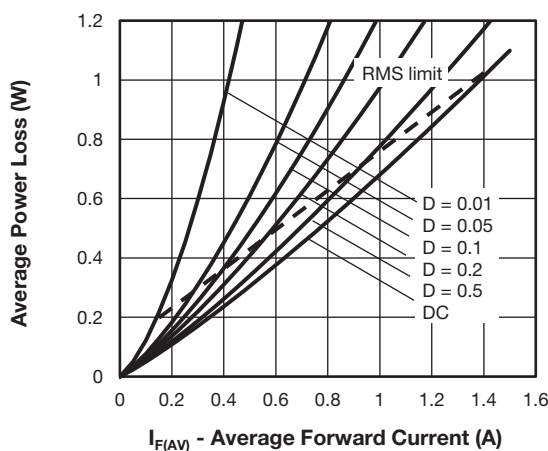


Fig. 6 - Forward Power Loss Characteristics

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{\theta JC}$;
 P_d = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 5);
 P_{dREV} = inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = rated V_R

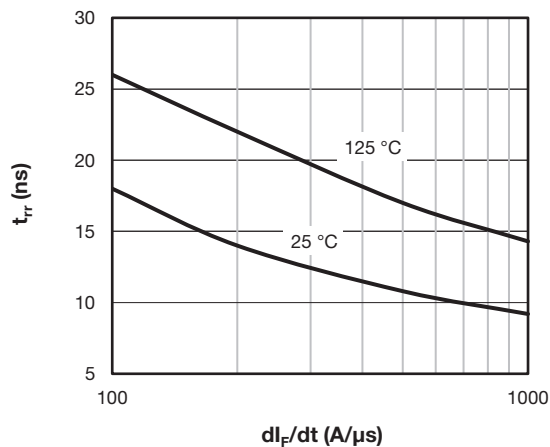
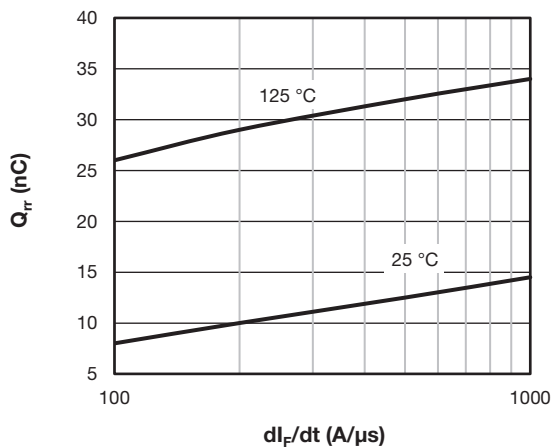
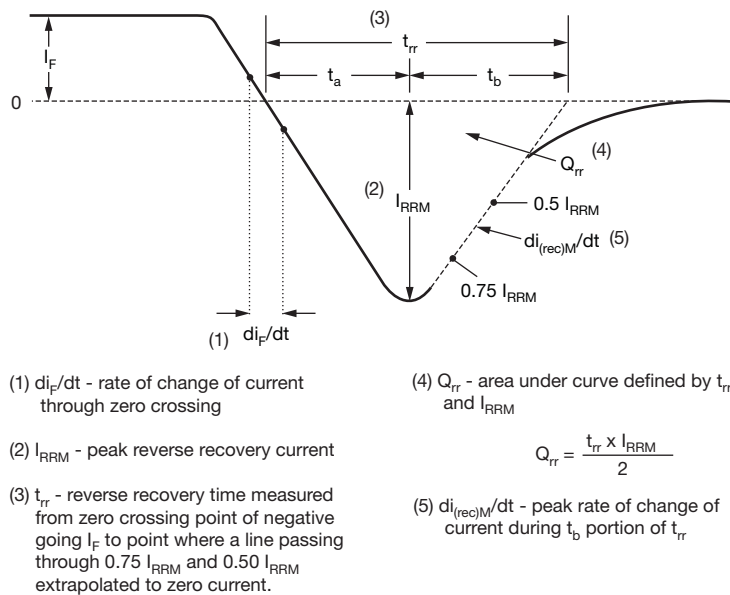

Fig. 7 - Typical Reverse Recovery Time vs. di_F/dt

Fig. 8 - Typical Stored Charge vs. di_F/dt


Fig. 9 - Reverse Recovery Waveform and Definitions

**ORDERING INFORMATION TABLE**

Device code	VS-	1	E	N	H	02	M3
	1	2	3	4	5	6	7
	1	-	Vishay Semiconductors product				
	2	-	Current rating (1 = 1 A)				
	3	-	Circuit configuration:				
			E = single diode				
	4	-	N = SMP package				
	5	-	Process type,				
			H = ultrafast recovery				
	6	-	Voltage code (02 = 200 V)				
	7	-	M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free				

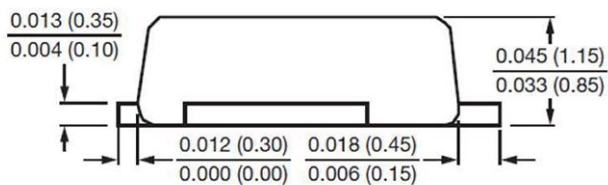
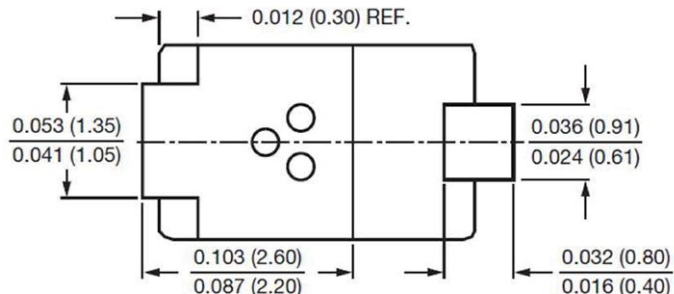
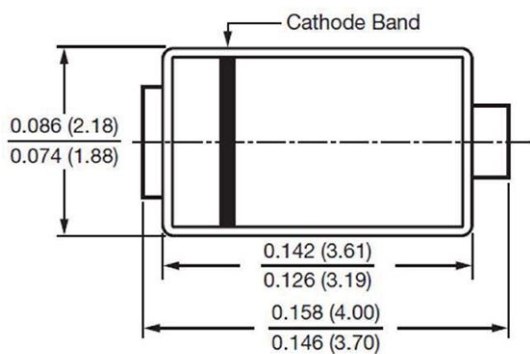
ORDERING INFORMATION (Example)			
PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-1ENH01-M3/84A	84A	3000	7" diameter plastic tape and reel
VS-1ENH01-M3/85A	85A	10 000	13" diameter plastic tape and reel
VS-1ENH02-M3/84A	84A	3000	7" diameter plastic tape and reel
VS-1ENH02-M3/85A	85A	10 000	13" diameter plastic tape and reel

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?96547
Part marking information	www.vishay.com/doc?96574
Packaging information	www.vishay.com/doc?88869
SPICE model	www.vishay.com/doc?96550

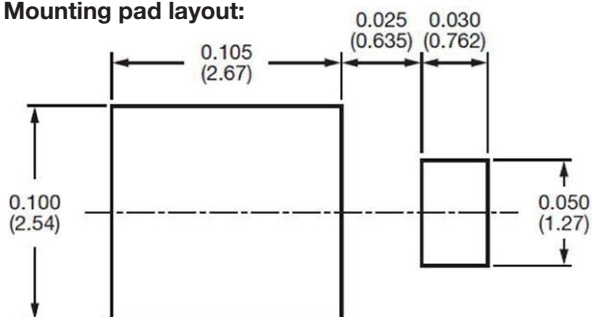


SMP (DO-220AA)

DIMENSIONS in inches (millimeters)



Mounting pad layout:





Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.